CMOS 8-Channel **Data Selector**

High-Voltage Types (20-Volt Rating)

■ CD4512B is an 8-channel data selector featuring a three-state output that can interface directly with, and drive, data lines of bus-oriented systems.

The CD4512B-series types are supplied in 16-lead hermetic dual-in-line ceramic packages (D and F suffixes), 16-lead dual-in-line plastic packages (E suffix), and in chip form (H suffix).

CD4512B Types

HANNE ETUGHI

3-STATE DISABLE

VDD * II

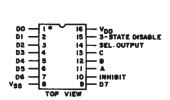
Features:

- 3-state output
- Standardized, symmetrical output characteristics
- 100% tested for quiescent current at 20 V
- 5-V, 10-V, and 15-V parametric ratings
- Maximum input current of 1 µA at 18 V over full packagetemperature range; 100 nA at 18 V and 25°C
- Noise margin (over full package-temperature range):

■ Meets all requirements of JEDEC Tentative Standard No. 13B, "Standard Specifications for Description of 'B' Series CMOS Devices"

Applications:

- Digital multiplexing
- Number-sequence generation
- Signal gating



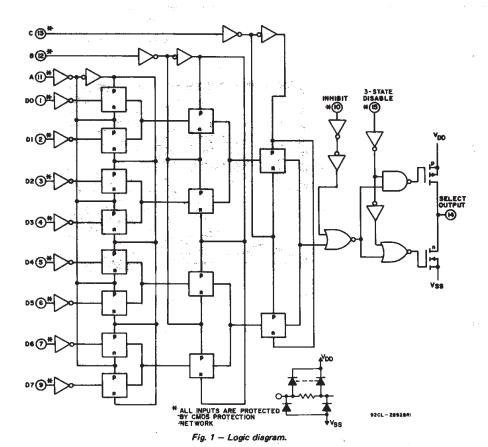
FUNCTIONAL DIAGRAM

TERMINAL ASSIGNMENT

RECOMMENDED OPERATING CONDITIONS

For maximum reliability, nominal operating conditions should be selected so that operation is always within the following ranges:

	LIMITS		AMUTO	
CHARACTERISTIC	MIN.	MAX.	UNITS	
Supply-Voltage Range (For T _A = Full Package Temperature Range)	3	18	· V	



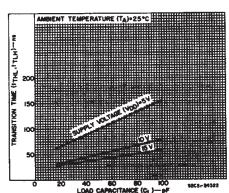
TRUTH TABLE

SEL. CONT.		INH	3-STATE	SEL				
Α	В	С	114171	DISABLE	OUTPUT			
0	0	0	0	0	D0			
1	0	0	0	0	D1			
0	1	0	0	0	D2			
1	1	0	0	0	D3			
0	0	1	0	0	D4			
1	0	1	0	0	D5			
0	1	1	0	0	D6			
1	1	1	0	0	D7			
х	x	X	1	0	0			
х	X	х	x	1	High Z			

1 = High Level

0 = Low Level

X = Don't Care



Typical transition time as a function of load capacitance.

CD4512B Types

MAXIMUM RATINGS, Absolute-Maximum Values:
DC SUPPLY-VOLTAGE RANGE, (VDD)
Voltages referenced to V _{SS} Terminal)0.5V to +20V
INPUT VOLTAGE RANGE, ALL INPUTS0.5V to VDD +0.5V
DC INPUT CURRENT, ANY ONE INPUT
POWER DISSIPATION PER PACKAGE (PD):
For T _A = -55°C to +100°C 500mW
For T _A = +100°C to +125°C
DEVICE DISSIPATION PER OUTPUT TRANSISTOR
FOR TA = FULL PACKAGE-TEMPERATURE RANGE (All Package Types)
OPERATING-TEMPERATURE RANGE (TA)
STORAGE TEMPERATURE RANGE (Tstg)65°C to +150°C
LEAD TEMPERATURE (DURING SOLDERING):
At distance 1/16 ± 1/32 inch (1.59 ± 0.79mm) from case for 10s max+265°C

AMMENT TEMPERATURE (TA)-25°C

Fig. 3 — Typical output low (sink) current characteristics.

STATIC ELECTRICAL CHARACTERISTICS N LIMITS AT INDICATED TEMPERATURES (°C) CHARAC-CONDITIONS **TERISTIC** T +25 S V_O VIN VOD (V) (V) (V) -55 40 +85 +125 Min. Max. Typ. 0,5 5 5 5 150 150 0.04 5 Quiescent 0,10 10 10 10 300 300 0.04 10 Device Current, 0,15 15 20 20 600 600 0.04 20 I_{DD} Max. 20 0,20 100 100 3000 3000 0.08 100 0,5 5 0.64 0.61 0.42 0.4 0.36 0.51 1 **Output Low** 0.5 0,10 10 1.5 (Sink) Current 1.6 1.1 0.9 1.3 2.6 IOL Min. 0,15 4 1.5 15 4.2 2.8 2.4 3.4 6.8 4.6 0,5 5 0.64 -0.61 -0.42 -0.36 -0.51 -1 mΑ Output High 2.5 (Source) 0,5 5 -2 -1.8-1.3-1.15-1.6 -3.2 Current. 10 -1.6 -1.5 9.5 0,10 -1.1-0.9-1.32.6 _ IOH Min. 13.5 0,15 15 -4.2 -2.8-4 -2.4-3.4-6.85 0,5 0.05 0 0.05 Output Voltage 10 0.05 Low-Level, 0,10 0 0.05 _ VOL Max. 0.15 15 0.05 0 0.05 Output 0,5 5 4.95 4.95 5 Voltage: 0,10 10 9.95 9.95 10 High-Level, VOH Min. 15 0,15 14.95 14.95 15 0.5.4.5 5 1.5 ---1.5 Input Low 1,9 10 3 3 Voltage VIL Max. .5,13.5 15 4 4 5 3.5 3.5 0.5,4.5 Input High 10 Voltage, 1,9 _ 7 7 ----_ VIH Min. 1.5,13,5 15 11 11 Ξ _ Input Current ±10-5 0,18 18 ±0.1 ±0.1 ±0.1 ±1 ±1 IIN Max. 3-State Output ±0.4 ±12 ±12 ±10~ ±0.4 Leakage 0,18 0,18 18 ±0.4 μΑ Current IOUT Max.

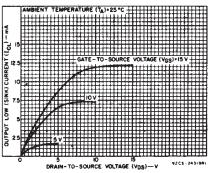


Fig. 4 — Minimum output low (sink) current characteristics.

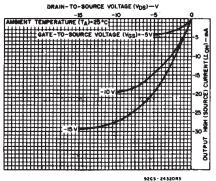


Fig. 5 - Typical output high (source) current characteristics.

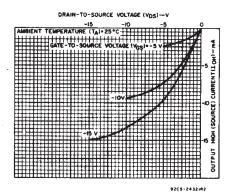


Fig. 6 — Minimum output high (source) current characteristics.

DYNAMIC ELECTRICAL CHARACTERISTICS at T_A = 25°C, Input t_r,t_f = 20 ns, C_L = 50 pF, R_L = 200 $k\Omega$

CHARACTERISTIC	TEST CONDITIONS	LIMITS		UNITS
The second secon	V _{DD} (V)		Max.	••••
Propagation Delay Time, tpHL, tpLH Inhibit to Output	5 10 15	140 70 50	280 140 100	
"A" Select to Output	5 10 15	200 85 60	400 170 120	ns
Data to Output	5 10 15	180 75 55	360 150 110	
3-State Disable Delay Time: tpZL, tpLZ, tpHZ, tpZH	5 10 15	60 30 20	120 60 40	ns
Transition Time, t _{THL} , t _{TLH}	5 10 15	100 50 40	200 100 80	ns
Input Capacitance, C _{IN} (Any Input)		5	7.5	pF

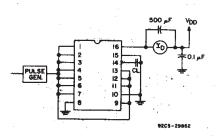


Fig. 9 - Dynamic power dissipation test circuit.

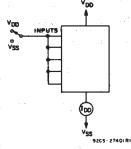


Fig. 10 - Quiescent device current test circuit.

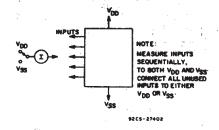


Fig. 11 - Input current test circuit.

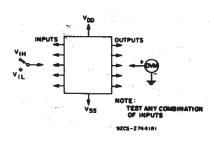
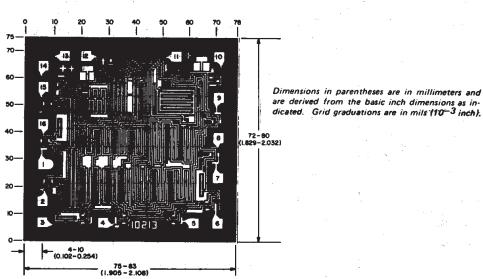


Fig. 12 - Input voltage test circuit.



10-8 AMBIENT TEMPERATURE (T_A) = 25 °C

10-8 AMBIENT TEMPERATURE (T_A) = 25

Fig. 7 — Typical dyanamic power dissipation as a function of frequency.

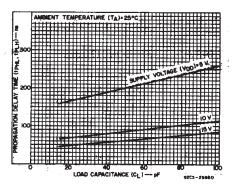


Fig. 8 — Typical propagation delay time as a function of load capacitance ("A" select to output).

Dimensions and pad layout for CD4512BH

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